



## LCD wiki MRB3514 3.5inch 16bit Parallel Port RTP and CTP Module User Manual

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## Product Description

The product is a 3.5-inch TFT LCD display module which supports switching between resistance touch screen and capacitive touch screen. It has 480×320 resolution, supports 16BIT RGB 65K color display, and the internal driver IC is ILI9488, which uses 16-bit parallel port communication. The module includes LCD display, resistance touch screen or capacitance touch screen and PCB backplane. It can be plugged into the TFT LCD slot of the STM32 series development board or used on the C51 platform.

## Product Features

- 3.5-inch color screen, support 16BIT RGB 65K color display, display rich colors
- 320×480 resolution for clear display
- Support 16-bit parallel data bus mode switching, fast transfer speed
- Supports ALIENTEK STM32 Mini, Elite, WarShip, Explorer, and Apollo development boards direct plug-in use
- Support switching between resistance touch screen and capacitive touch screen
- Provides a rich sample program for STM32 and C51 platforms
- Military-grade process standards, long-term stable work
- Provide underlying driver technical support

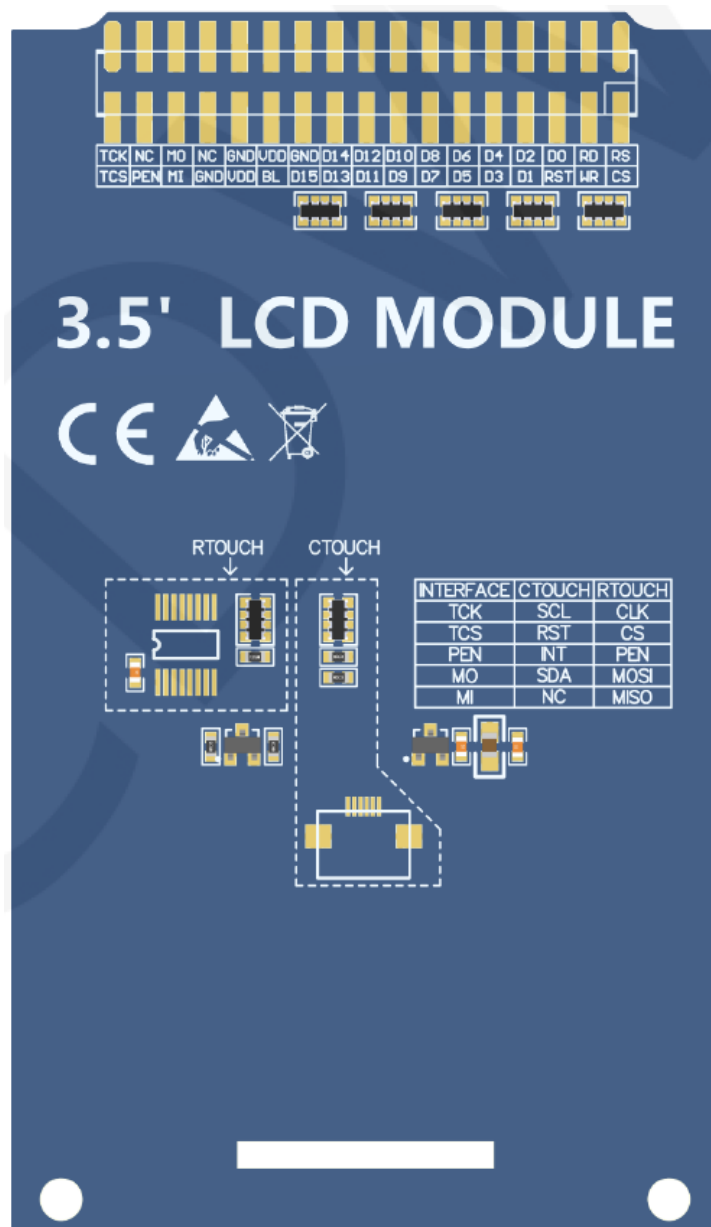
## Product Parameters

Name	Description
Display Color	16BIT RGB 65K color
SKU	MRB3514
Screen Size	3.5(inch)
Screen Type	TFT
Driver IC	ILI9488
Resolution	480*320 (Pixel)
Module Interface	16Bit parallel interface
Active Area	48.96x73.44 (mm)
Touch Screen Type	Resistance touch screen or Capacitive touch screen
Touch IC	Resistance touch screen:XPT2046 Capacitive touch screen :GT911
Module PCB Size	56.41x97.60 (mm)
Operating Temperature	-10℃~60℃
Storage Temperature	-20℃~70℃
Operating Voltage	3.3V / 5V
Power Consumption	TBD
Product Weight(Including packaging)	57g

## Interface Description

NOTE:

- The hardware of the module supports switching between resistance touch screen and capacitive touch screen:
  - Use resistance touch screen: solder the components in the dotted line box of RTOUCH, and do not need to weld the components in the dotted line box of CTOUCH;
  - Use capacitive touch screen: solder the components in the dotted line box of CTOUCH, and do not need to weld the components in the dotted line box of RTOUCH;



2. This module can be directly inserted into the TFTLCD slot of the punctual atom development board, no manual wiring is required.
3. The hardware of this module only supports 16 bit mode

#### Important Note:

1. The following pin numbers 1~34 are the pin number of Module pin with PCB backplane of our company. If you purchase a bare screen, please refer to the pin definition of the bare screen specification, refer to the wiring according to the signal type instead of directly Wire according to the following module pin numbers. For example: CS is 1 pin on our module. It may be x pin on different size bare screen.
2. About VCC supply voltage: If you buy a module with PCB backplane, VCC/VDD power supply can be connected to 5V or 3.3V (module has integrated ultra low dropout 5V to 3V circuit), if you buy a bare screen LCD, remember to only connect 3.3V.
3. About the backlight voltage: The module with the PCB backplane has integrated triode backlight control circuit, which only needs to input the high level of the BL pin or the PWM wave to illuminate the backlight. If you are buying a bare screen, the LEDAx is connected to 3.0V-3.3V and the LEDKx is grounded.

Number	Module Pin	Pin Description
1	CS	LCD reset control pin( low level enable)
2	RS	LCD register / data selection control pin (high level: register, low level: data)
3	WR	LCD write control pin
4	RD	LCD read control pin
5	RST	LCD reset control pin( low level reset)
6	D0	LCD data bus 16-bit pin
7	D1	

8	D2	
9	D3	
10	D4	
11	D5	
12	D6	
13	D7	
14	D8	
15	D9	
16	D10	
17	D11	
18	D12	
19	D13	
20	D14	
21	D15	
22	GND	Module power ground pin
23	BL	LCD backlight control pin(High level light)
24	VDD	Module power positive pin (module has integrated voltage regulator IC, It can be connected to 5V or 3.3V on STM32 and 5V on C51)
25	VDD	
26	GND	Module power ground pin
27	GND	
28	NC	LCD backlight power positive pin (default shared onboard backlight power supply, this pin can not be connected)
29	MI	Resistance touch screen SPI bus read signal
30	MO	Resistance touch screen SPI bus write signal or capacitance touch screen IIC bus data signal
31	PEN	Capacitive or resistive touch screen interrupt detection pin (low level when touch occurs)
32	NC	Not defined, no need to use
33	TCS	Resistance touch screen chip selection control signal or capacitive touch screen reset signal (low level reset)
34	TCK	Resistance touch screen SPI bus or capacitive touch screen IIC bus clock signal

## Hardware Configuration

The LCD module hardware circuit comprises six parts: an LCD display control circuit, a power control circuit, a Impedance balance adjusting circuit, a capacitive touch screen control circuit , a resistance touch screen control circuit and a backlight control circuit. LCD display control circuit for controlling the pins of the LCD, including control pins and data transfer pins.

Power control circuit for stabilizing the supply voltage and selecting the external supply voltage.

The impedance balance adjusting circuit is used to balance the impedance between MCU pin and LCD pin.

resistance touch screen control circuit is used to control touch screen interrupt acquisition, data sampling, AD

conversion, data transmission, etc

Capacitive touch screen control circuit is used to control touch screen interrupt acquisition, data sampling, AD conversion, data transmission, etc.

A backlight control circuit is used to control the brightness of the backlight.

## Working principle

### Introduction to ITI9488 Controller

The ITI488 controller supports a maximum resolution of 320\*480 and has a 345600-byte GRAM. It also supports 8-bit, 9-bit, 16-bit, 18-bit and 24-bit parallel port data buses. It also supports 3-wire and 4-wire SPI serial ports. Since the supported resolution is relatively large and the amount of data transmitted is large, the parallel port transmission is adopted, and the transmission speed is fast. ITI9488 also supports 65K, 262K and 16.7M RGB color display, display color is very rich, while supporting rotating display and scroll display and video playback, display in a variety of ways.

The ITI9488 controller uses 16bit (RGB565) to control a pixel display, so it can display up to 65K colors per pixel. The pixel address setting is performed in the order of rows and columns, and the incrementing and decreasing direction is determined by the scanning mode. The ITI9488 display method is performed by setting the address and then setting the color value.

### Introduction to parallel port communication

The parallel port communication write mode timing is as shown below:

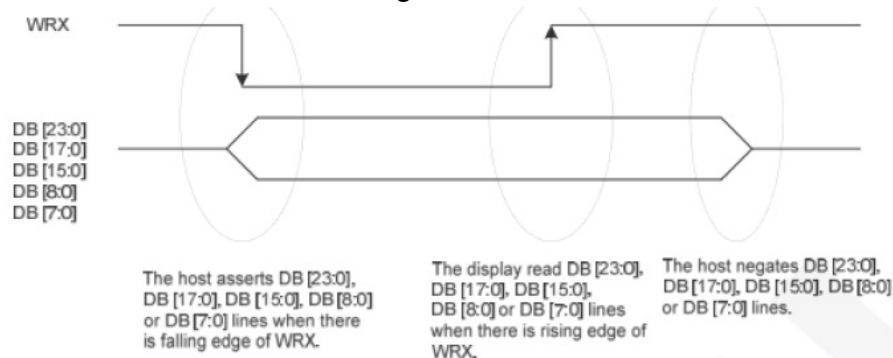
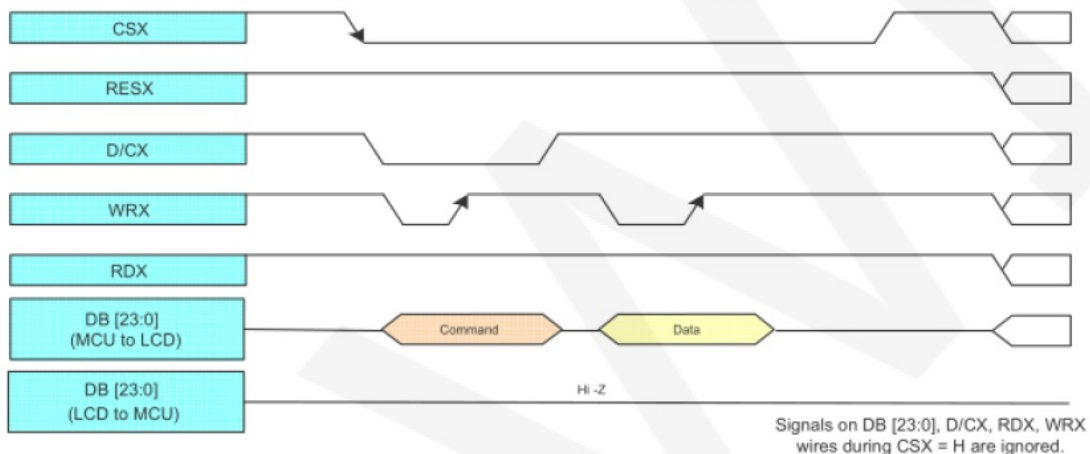


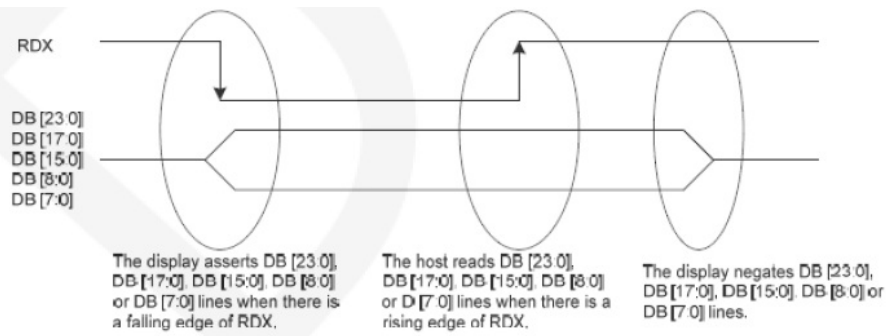
Figure 1: DBI Type B Write Cycle

**Note:** WRX is an unsynchronized signal that can be terminated when not being used.

When the D/CX signal is driven to low level, the input data on the interface is interpreted as command information. The D/CX signal can also be pulled to high level when the data is RAM data or command parameter.



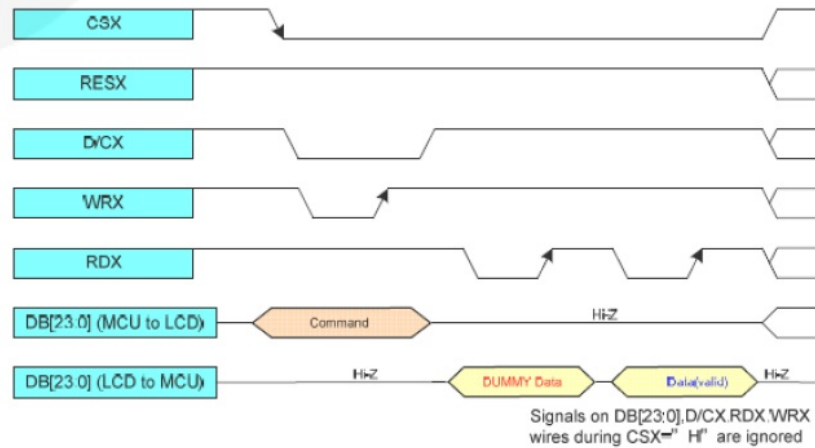
The timing of the parallel port communication read mode is shown in the figure below:



**Figure 3: DBI Type B Read Cycle**

**Note:** RDX is an unsynchronized signal that can be terminated when not being used.

When the D/CX signal is driven to the low level, the input data on the interface is interpreted as internal status or parameter data. The D/CX signal can also be pulled to a high level when the data on the interface is RAM data or a command parameter data.



CSX is a chip select signal for enabling and disabling parallel port communication, active low

RESX is an external reset signal, active low

D/CX is the data or command selection signal, 1-write data or command parameters, 0-write command

WRX is a write data control signal

RDX is a read data control signal

D[X:0] is a parallel port data bit, which has four types: 8-bit, 9-bit, 16-bit, and 18-bit.

When performing a write operation, on the basis of the reset, first set the data or command selection signal, then pull the chip select signal low, then input the content to be written from the host, and then pull the write data control signal low. When pulled high, data is written to the LCD control IC on the rising edge of the write control signal. Finally, the chip select signal is pulled high and a data write operation is completed.

When entering the read operation, on the basis of the reset, first pull the chip select signal low, then pull the data or command select signal high, then pull the read data control signal low, and then read the data from the LCD control IC. And then The read data control signal is pulled high, and the data is read out on the rising edge of the read data control signal. Finally, the chip select signal is pulled high, and a data read operation is completed.

## Instructions for use

### STM32 instructions

#### Wiring instructions:

See the interface description for pin assignments.

#### Note:

1. This module can be directly inserted into the TFTLCD slot of the punctual atom development board, no manual wiring is required.
2. The following internal plug-in pins of the corresponding MCU refer to the MCU pins directly connected to the TFTLCD slot inside the development board, only for reference.



## MiniSTM32 development board TFTLCD socket in-line instructions

Number	Module Pin	Corresponding TFTLCD socket pin	Corresponding to STM32F103RCT6 microcontroller internal connection pin
1	CS	CS	PC9
2	RS	RS	PC8
3	WR	WR	PC7
4	RD	RD	PC6
5	RST	RST	PC4
6	D0	D0	PB0
7	D1	D1	PB1
8	D2	D2	PB2
9	D3	D3	PB3
10	D4	D4	PB4
11	D5	D5	PB5
12	D6	D6	PB6
13	D7	D7	PB7
14	D8	D8	PB8
15	D9	D9	PB9
16	D10	D10	PB10
17	D11	D11	PB11
18	D12	D12	PB12
19	D13	D13	PB13
20	D14	D14	PB14
21	D15	D15	PB15
22	GND	GND	GND
23	BL	BL	PC10
24	VDD	3.3	3.3V
25	VDD	3.3	3.3V
26	GND	GND	GND
27	GND	GND	GND
28	NC	Not used	5V
29	MI	MISO	PC2
30	MO	MOSI	PC3
31	PEN	PEN	PC1
32	NC	Not used	NC
33	TCS	TCS	PC13
34	TCK	CLK	PC0

## Elite STM32 development board TFTLCD socket in-line instructions

Number	Module Pin	Corresponding TFTLCD socket pin	Corresponding to STM32F103ZET6 microcontroller internal connection pin
1	CS	CS	PG12
2	RS	RS	PG0
3	WR	WR	PD5
4	RD	RD	PD4
5	RST	RST	reset pin
6	D0	D0	PD14
7	D1	D1	PD15
8	D2	D2	PD0
9	D3	D3	PD1
10	D4	D4	PE7
11	D5	D5	PE8
12	D6	D6	PE9
13	D7	D7	PE10
14	D8	D8	PE11
15	D9	D9	PE12
16	D10	D10	PE13
17	D11	D11	PE14
18	D12	D12	PE15
19	D13	D13	PD8
20	D14	D14	PD9
21	D15	D15	PD10
22	GND	GND	GND
23	BL	BL	PB0
24	VDD	VDD	3.3V
25	VDD	VDD	3.3V
26	GND	GND	GND
27	GND	GND	GND
28	NC	Not used	5V
29	MI	MISO	PB2
30	MO	MOSI	PF9
31	PEN	PEN	PF10
32	NC	Not used	NC
33	TCS	TCS	PF11
34	TCK	CLK	PB1

## WarShip STM32 development board TFTLCD socket in-line instructions

Number	Module Pin	Corresponding TFTLCD socket pin	Corresponding to STM32F103ZET6 microcontroller internal connection pin	
			V2	V3
1	CS	CS	PG12	
2	RS	RS	PG0	
3	WR	WR	PD5	
4	RD	RD	PD4	
5	RST	RST	reset pin	
6	D0	D0	PD14	
7	D1	D1	PD15	
8	D2	D2	PD0	
9	D3	D3	PD1	
10	D4	D4	PE7	
11	D5	D5	PE8	
12	D6	D6	PE9	
13	D7	D7	PB7	
14	D8	D8	PB8	
15	D9	D9	PB9	
16	D10	D10	PB10	
17	D11	D11	PB11	
18	D12	D12	PB12	
19	D13	D13	PB13	
20	D14	D14	PB14	
21	D15	D15	PB15	
22	GND	GND	GND	
23	BL	BL	PC10	
24	VDD	3.3	3.3V	
25	VDD	3.3	3.3V	
26	GND	GND	GND	
27	GND	GND	GND	
28	NC	Not used	5V	
29	MI	MISO	PC2	
30	MO	MOSI	PC3	
31	PEN	PEN	PC1	
32	NC	Not used	NC	
33	TCS	TCS	PC13	
34	TCK	CLK	PC0	

## Elite STM32 development board TFTLCD socket in-line instructions

Number	Module Pin	Corresponding TFTLCD socket pin	Corresponding to STM32F103ZET6 microcontroller internal connection pin
1	CS	CS	PG12
2	RS	RS	PG0
3	WR	WR	PD5
4	RD	RD	PD4
5	RST	RST	reset pin
6	D0	D0	PD14
7	D1	D1	PD15
8	D2	D2	PD0
9	D3	D3	PD1
10	D4	D4	PE7
11	D5	D5	PE8
12	D6	D6	PE9
13	D7	D7	PE10
14	D8	D8	PE11
15	D9	D9	PE12
16	D10	D10	PE13
17	D11	D11	PE14
18	D12	D12	PE15
19	D13	D13	PD8
20	D14	D14	PD9
21	D15	D15	PD10
22	GND	GND	GND
23	BL	BL	PB0
24	VDD	VDD	3.3V
25	VDD	VDD	3.3V
26	GND	GND	GND
27	GND	GND	GND
28	NC	Not used	5V
29	MI	MISO	PB2
30	MO	MOSI	PF9
31	PEN	PEN	PF10
32	NC	Not used	NC
33	TCS	TCS	PF11
34	TCK	CLK	PB1

## WarShip STM32 development board TFTLCD socket in-line instructions

Number	Module Pin	Corresponding TFTLCD socket pin	Corresponding to STM32F103ZET6 microcontroller internal connection pin	
			V2	V3
1	CS	CS	PG12	
2	RS	RS	PG0	
3	WR	WR	PD5	
4	RD	RD	PD4	
5	RST	RST	reset pin	
6	D0	D0	PD14	
7	D1	D1	PD15	
8	D2	D2	PD0	
9	D3	D3	PD1	
10	D4	D4	PE7	
11	D5	D5	PE8	
12	D6	D6	PE9	
13	D7	D7	PE10	
14	D8	D8	PE11	
15	D9	D9	PE12	
16	D10	D10	PE13	
17	D11	D11	PE14	
18	D12	D12	PE15	
19	D13	D13	PD8	
20	D14	D14	PD9	
21	D15	D15	PD10	
22	GND	GND	GND	
23	BL	BL	PB0	
24	VDD	VDD	3.3V	
25	VDD	VDD	3.3V	
26	GND	GND	GND	
27	GND	GND	GND	
28	NC	Not used	5V	

28	NC	Not used	5V	
29	MI	MISO	PF8	PB2
30	MO	MOSI	PF9	
31	PEN	PEN	PF10	
32	NC	Not used	NC	
33	TCS	TCS	PB2	PF11
34	TCK	CLK	PB1	

**STM32F407VGT6 development board TFTLCD socket in-line instructions**

Number	Module Pin	Corresponding TFTLCD socket pin	Corresponding to STM32F407ZGT6 microcontroller internal connection pin
1	CS	CS	PD7
2	RS	RS	PD11
3	WR	WR	PD5
4	RD	RD	PD4
5	RST	RST	reset pin

6	D0	D0	PD14
7	D1	D1	PD15
8	D2	D2	PD0
9	D3	D3	PD1
10	D4	D4	PE7
11	D5	D5	PE8
12	D6	D6	PE9
13	D7	D7	PE10
14	D8	D8	PE11
15	D9	D9	PE12
16	D10	D10	PE13
17	D11	D11	PE14
18	D12	D12	PE15
19	D13	D13	PD8
20	D14	D14	PD9
21	D15	D15	PD10
22	GND	GND	GND
23	BL	BL	PB15
24	VDD	VDD	3.3V
25	VDD	VDD	3.3V
26	GND	GND	GND
27	GND	GND	GND
28	NC	Not used	5V
29	MI	MISO	PB2
30	MO	MOSI	PC4
31	PEN	PEN	PB1
32	NC	Not used	NC
33	TCS	TCS	PC13
34	TCK	CLK	PB0

## Explorer STM32F4 development board TFTLCD socket in-line instructions

Number	Module Pin	Corresponding TFTLCD socket pin	Corresponding to STM32F407ZGT6 microcontroller internal connection pin
1	CS	CS	PG12
2	RS	RS	PF12
3	WR	WR	PD5
4	RD	RD	PD4
5	RST	RST	reset pin
6	D0	D0	PD14
7	D1	D1	PD15
8	D2	D2	PD0
9	D3	D3	PD1
10	D4	D4	PE7
11	D5	D5	PE8
12	D6	D6	PE9
13	D7	D7	PE10
14	D8	D8	PE11
13	D7	D7	PE10
14	D8	D8	PE11
15	D9	D9	PE12
16	D10	D10	PE13
17	D11	D11	PE14
18	D12	D12	PE15
19	D13	D13	PD8
20	D14	D14	PD9
21	D15	D15	PD10
22	GND	GND	GND
23	BL	BL	PB15
24	VDD	VDD	3.3V
25	VDD	VDD	3.3V
26	GND	GND	GND
27	GND	GND	GND
28	NC	Not used	5V



29	<b>MI</b>	MISO	PB2
30	<b>MO</b>	MOSI	PF11
31	<b>PEN</b>	PEN	PB1
32	<b>NC</b>	Not used	NC
33	<b>TCS</b>	TCS	PC13
34	<b>TCK</b>	CLK	PB0

### Apollo STM32F4/F7 development board TFTLCD socket in-line instructions

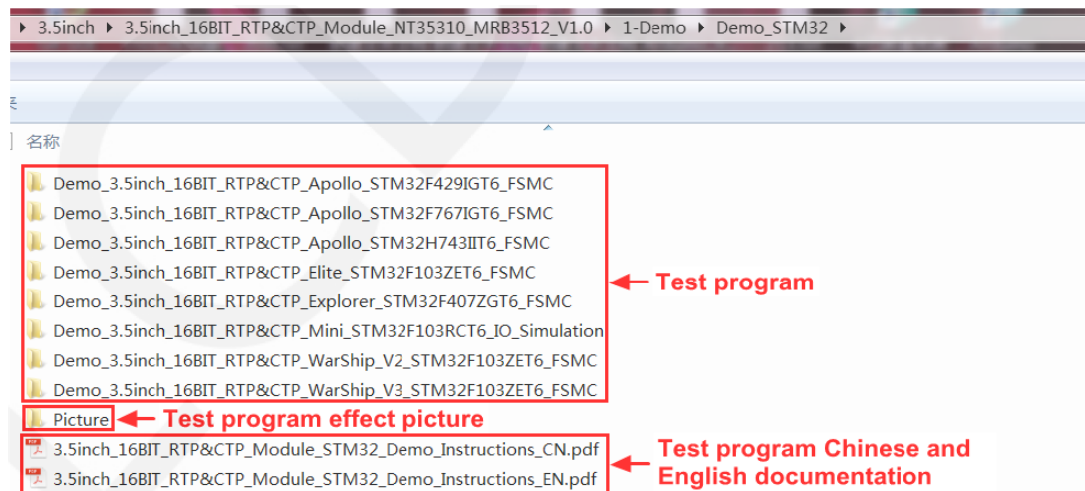
Number	Module Pin	Corresponding TFTLCD socket pin	Corresponding to STM32F429IGT6, STM32F767IGT6, STM32H743IIT6 microcontroller internal connection pin
1	<b>CS</b>	CS	PD7
2	<b>RS</b>	RS	PD13
3	<b>WR</b>	WR	PD5
4	<b>RD</b>	RD	PD4
5	<b>RST</b>	RST	reset pin
6	<b>D0</b>	D0	PD14
7	<b>D1</b>	D1	PD15
8	<b>D2</b>	D2	PD0
9	<b>D3</b>	D3	PD1
10	<b>D4</b>	D4	PE7
11	<b>D5</b>	D5	PE8
12	<b>D6</b>	D6	PE9
13	<b>D7</b>	D7	PE10
14	<b>D8</b>	D8	PE11
15	<b>D9</b>	D9	PE12
16	<b>D10</b>	D10	PE13
17	<b>D11</b>	D11	PE14
18	<b>D12</b>	D12	PE15
19	<b>D13</b>	D13	PD8
20	<b>D14</b>	D14	PD9
21	<b>D15</b>	D15	PD10

22	GND	GND	GND
23	BL	BL	PB5
24	VDD	VDD	3.3V
25	VDD	VDD	3.3V
26	GND	GND	GND
27	GND	GND	GND
28	NC	Not used	5V
29	MI	MISO	PG3
30	MO	MOSI	PI3
31	PEN	PEN	PH7
32	NC	Not used	NC
33	TCS	TCS	PI8
34	TCK	CLK	PH6

## Operating Steps

- A. Connect the LCD module(As shown in Picture 1) and the STM32 MCU according to the above wiring instructions, and power on;
- B. Select the C51 test program to be tested, as shown below:

(Please refer to the test program documentation for the test program description.)



- C. Open the selected test program project, compile and download; detailed description of the STM32 test program compilation and download can be found in the following document:  
[http://www.lcdwiki.com/res/PublicFile/STM32\\_Keil\\_Use\\_Illustration\\_EN.pdf](http://www.lcdwiki.com/res/PublicFile/STM32_Keil_Use_Illustration_EN.pdf)
- D. If the LCD module displays characters and graphics normally, the program runs successfully

## C51 instructions

### Wiring instructions:

See the interface description for pin assignments.

### Note:

1. Since the input and output levels of the GPIO of the STC12C5A60S2 microcontroller are 5V, the capacitive touch IC cannot work normally (only 1.8~3.3V can be accepted). If you want to use the capacitive touch

function, you need to connect to the level conversion module;

2. Since the STC89C52RC microcontroller does not have a push-pull output function, the backlight control pin needs to be connected to a 3.3V power supply to be properly lit.
3. Since the STC89C52RC microcontroller's Flash capacity is too small (less than 25KB), the program with touch function cannot be downloaded, so the touch screen does not need wiring.

STC12C5A60S2 microcontroller test program wiring instructions		
Number	Module Pin	Corresponding to STC12 development board wiring pin
1	CS	P13
2	RS	P12
3	WR	P11
4	RD	P10
5	RST	P33
6	D0	P00
7	D1	P01
8	D2	P02
9	D3	P03
10	D4	P04
11	D5	P05
12	D6	P06
13	D7	P07
14	D8	P20
15	D9	P21
16	D10	P22
17	D11	P23
18	D12	P24
19	D13	P25
20	D14	P26
21	D15	P27
22	GND	GND
23	BL	P31
24	VDD	5V
25	VDD	5V

26	GND	GND
27	GND	GND
28	NC	No need to connect
29	MI	No need to connect
30	MO	P34
31	PEN	P32
32	NC	No need to connect
33	TCS	P37
34	TCK	P36

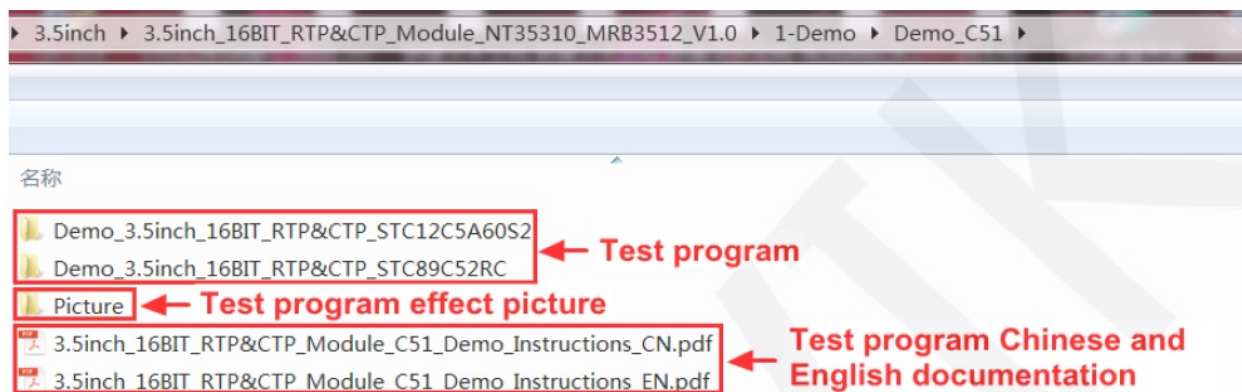
### STC89C52RC microcontroller test program wiring instructions

Number	Module Pin	Corresponding to STC89 development board wiring pin
1	CS	P13
2	RS	P12
3	WR	P11
4	RD	P10
5	RST	P14
6	D0	P30
7	D1	P31
8	D2	P32
9	D3	P33
10	D4	P34
11	D5	P35
12	D6	P36
13	D7	P37
14	D8	P20
15	D9	P21
16	D10	P22
17	D11	P23
18	D12	P24
19	D13	P25

20	D14	P26
21	D15	P27
22	GND	GND
23	BL	3.3V
24	VDD	5V
25	VDD	5V
26	GND	GND
27	GND	GND
28	NC	No need to connect
29	MI	No need to connect
30	MO	No need to connect
31	PEN	No need to connect
32	NC	No need to connect
33	TCS	No need to connect
34	TCK	No need to connect

## Operating Steps

1. A. Connect the LCD module (As shown in Picture 1) and the C51 MCU according to the above wiring instructions, and power on;
2. B. Select the C51 test program to be tested, as shown below:  
(Test program description please refer to the test program description document in the test package)

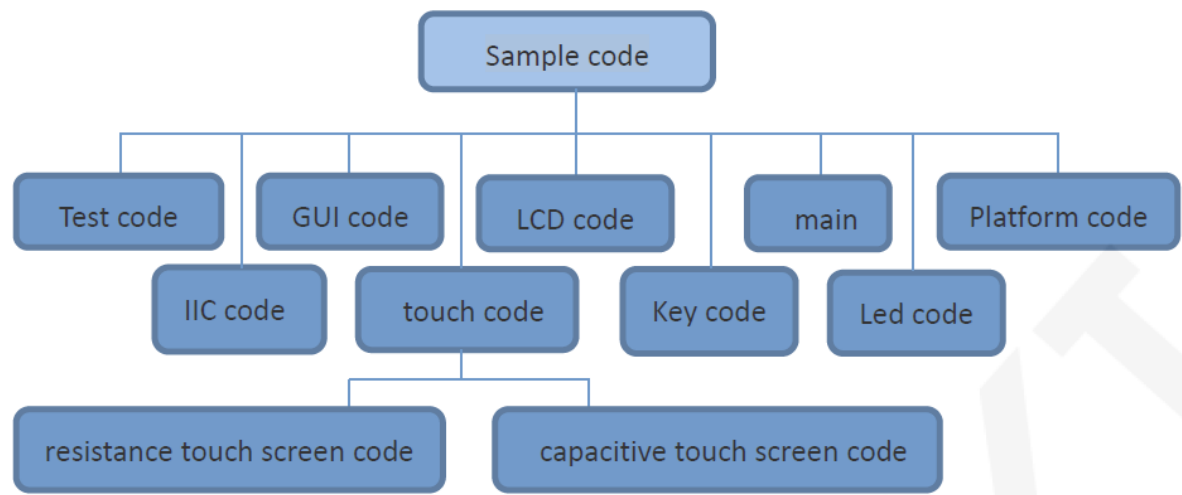


3. C. Open the selected test program project, compile and download;  
detailed description of the C51 test program compilation and download can be found in the following document:  
[http://www.lcdwiki.com/res/PublicFile/C51\\_Keil%26stc-isp\\_Use\\_Illustration\\_EN.pdf](http://www.lcdwiki.com/res/PublicFile/C51_Keil%26stc-isp_Use_Illustration_EN.pdf)
4. D. If the LCD module displays characters and graphics normally, the program runs successfully

## Software Description

### Code Architecture

- A. C51 and STM32 code architecture description The code architecture is shown below:



- The Demo API code for the main program runtime is included in the test code;
- LCD initialization and related bin parallel port write data operations are included in the LCD code;
- Drawing points, lines, graphics, and Chinese and English character display related operations are included in the GUI code;
- The main function implements the application to run;
- Platform code varies by platform;
- The IIC code is used by the capacitive touch IC GT911, including IIC initialization, data writing and reading, etc;
- Touch code includes two parts: resistance touch screen code and capacitance touch screen (gt911) code;
- The key processing related code is included in the key code (the C51 platform does not have a button processing code);
- The code related to the led configuration operation is included in the led code(the C51 platform does not have a led processing code);

## GPIO definition description

### • A. STM32 test program GPIO definition description

The GPIO definition of the LCD screen of the STM32 test program is placed in the lcd.h file, which is defined in two ways:

- STM32F103RCT6 microcontroller test program uses IO analog mode (it does not support FSMC bus)
- Other STM32 MCU test programs use FSMC bus mode STM32F103RCT6 MCU IO analog test program LCD screen GPIO definition as shown below:

```

////////////////////////////////////
//-----LCD端口定义-----
#define GPIO_TYPE  GPIOC  //GPIO组类型
#define LED        10      //背光控制引脚      PC10
#define LCD_CS     9       //片选引脚          PC9
#define LCD_RS     8       //寄存器/数据选择引脚 PC8
#define LCD_RST    4       //复位引脚          PC4
#define LCD_WR     7       //写引脚            PC7
#define LCD_RD     6       //读引脚            PC6

//PB0~15,作为数据线
//注意: 如果使用8位模式数据总线, 则液晶屏的数据高8位是接到MCU的高8位总线
//举例: 如果接8位模式则本示例接线为液晶屏DB10-DB17对应接至单片机GPIOB_Pin10-GPIOB_Pin17
//举例: 如果是16位模式: DB0-DB7分别接GPIOB_Pin0-GPIOB_Pin7,DB10-DB17对应接至单片机GPIOB_Pin10-GPIOB_Pin17
#define DATAOUT(x) GPIOB->ODR=x; //数据输出
#define DATAIN    GPIOB->IDR;   //数据输入

```

- FSMC test program lcd screen GPIO is defined as shown below (take STM32F103ZET6 microcontroller FSMC test program as an example):

```

////////////////////////////////////
//-----LCD端口定义-----
#define LED        0       //背光控制引脚      PB0

//QDtech全系列模块采用了三极管控制背光亮灭, 用户也可以接PWM调节背光亮亮度
#define LCD_LED    PBout(LED) //LCD背光

//LCD地址结构体
typedef struct
{
    #if LCD_USE8BIT_MODEL
        vu8 LCD_REG;
        vu8 LCD_RAM;
    #else
        vu16 LCD_REG;
        vu16 LCD_RAM;
    #endif
} LCD_TypeDef;

//使用NOR/SRAM的 Bank1.sector4,地址位HADDR[27,26]=11 A10作为数据命令区分线
#if LCD_USE8BIT_MODEL
//使用8位模式时, STM32内部地址不需要右移一位
#define LCD_BASE    ((u32)(0x6C000000 | 0x000003FF))
#else
//使用16位模式时, 注意设置时STM32内部地址需要右移一位对齐!
#define LCD_BASE    ((u32)(0x6C000000 | 0x000007FE))
#endif
#define LCD         ((LCD_TypeDef *) LCD_BASE)

```

- STM32 platform touch screen related code contains two parts :resistance touch screen code and capacitance touch screen code.
- Resistance touch screen GPIO definition is placed in the rtp.h file as shown below (take the STM32F103ZET6 microcontroller IO analog test program as an example):



```
//与触摸屏芯片连接引脚
//与触摸屏芯片连接引脚
#define PEN PCin(1) //PC1 INT
#define DOUT PCin(2) //PC2 MISO PC2--PB14
#define TDIN PCout(3) //PC3 MOSI PC3--PB15
#define TCLK PCout(0) //PC0 SCLK PC0--PB13
#define TCS PCout(13) //PC13 CS
```

The capacitance touch screen related GPIO definition consists of two parts: IIC's GPIO definition and screen interrupt and reset GPIO definition.

- The IIC GPIO definition is placed in the ctpiic.h file as shown below (take the STM32F103RCT6 microcontroller FSMC test program as an example):

```
//IO方向设置
#define GT_SDA_IN() {GPIOF->CRH&=0xFFFFF0F;GPIOF->CRH|=8<<4*1;}
#define GT_SDA_OUT() {GPIOF->CRH&=0xFFFFF0F;GPIOF->CRH|=3<<4*1;}

//IO操作函数
#define GT_IIC_SCL PBout(1) //SCL
#define GT_IIC_SDA PFout(9) //SDA
#define GT_READ_SDA PFin(9) //输入SDA
```

- The interrupt of the touch screen and the reset GPIO definition are placed in GT911.h, as shown in the following figure (take the STM32F103ZET6 microcontroller FSMC test program as an example):

```
#define RST_OUT() { GPIOF->CRH&=0xFFFF0FF;GPIOF->CRH|=0X00003000;} //set RSSET pin to output
#define INT_OUT() { GPIOF->CRH&=0xFFFF0FF;GPIOF->CRH|=0X00000300;} //set RSSET pin to output
#define INT_IN() { GPIOF->CRH&=0xFFFFFFF;GPIOC->CRH|=0X00000400;} //set RSSET pin to output
//#define INT_OUT() { GPIOB->CRH&=0xFFFFFFF0;GPIOB->CRH|=0X00000003;} //set INT pin to output
//#define INT_IN() { GPIOB->CRH&=0xFFFFFFF0;GPIOB->CRH|=0X00000004;} //set INT pin to input

//RST--PF11
//INT--PF10
#define RST_CTRL PFout(11) //GT911 RESET pin out high or low
#define INT_CTRL PFout(10) //GT911 INT pin out high or low
#define INT_GET PFin(10) //Get GT911 INT pin status
```

#### • B. C51 test program GPIO definition description

C51 test program lcd screen GPIO definition is placed in the lcd.h file, as shown below(Taking the STC12C5A60S2 microcontroller test program as an example):

```
//IO连接
#define LCD_DataPortH P2 //高8位数据口,8位模式下只使用高8位
#define LCD_DataPortL P0 //低8位数据口,8位模式下低8位可以不接线,请确认P
sbit LCD_RS = P1^2; //数据/命令切换
sbit LCD_WR = P1^1; //写控制
sbit LCD_RD = P1^0; //读控制
sbit LCD_CS = P1^3; //片选
sbit LCD_RESET = P3^3; //复位
sbit LCD_BL=P3^1; //背光控制,如果不需要控制,接3.3V
```

Parallel pin definition needs to select the whole set of GPIO port groups, such as P0, P2, etc., so that when transferring data, the operation is convenient. Other pins can be defined as any free GPIO.

C51platform touch screen related code contains two parts :resistance touch screen code and capacitance touch screen code.

- Resistance touch screen GPIO definition is placed in the rtp.h file as shown below (Taking the STC12C5A60S2 microcontroller test program as an example):



```

sbit DCLK      = P3^6;
sbit TCS       = P3^7;
sbit DIN       = P3^4;
sbit DOUT      = P3^5;
sbit Penirq    = P3^2;    //检测触摸屏响应信号

```

The capacitance touch screen related GPIO definition consists of two parts: IIC's GPIO definition and screen interrupt and reset GPIO definition.

- The IIC GPIO definition is placed in the gtiic.h file as shown below (take the STC12C5A60S2 microcontroller test program as an example):

```

//引脚定义
sbit GT_IIC_SCL = P3^6;    //SCL
sbit GT_IIC_SDA = P3^4;    //SDA

```

- The interrupt of the screen and the reset GPIO definition are placed in GT911.h, as shown in the following figure (take the STC12C5A60S2 microcontroller test program as an example):

```

sbit RST_CTRL = P3^7; //GT911 RESET pin out high or low
sbit INT_CTRL = P3^2; //GT911 INT pin out high or low

```

The GPIO definition of the touch screen can be modified and can be defined as any other free GPIO.

### Parallel port communication code implementation

- A. STM32 test program parallel port communication code implementation

The STM32 test program parallel port communication code is placed in the LCD.c file, which is implemented in two ways:

- STM32F103RCT6 microcontroller test program uses IO analog mode (it does not support FSMC bus)
- Other STM32 MCU test programs use FSMC bus mode

**The IO simulation test program is implemented as shown below:**

```

void LCD_write(u16 VAL)
{
    LCD_CS_CLR;
    DATAOUT(VAL);
    LCD_WR_CLR;
    LCD_WR_SET;
    LCD_CS_SET;
}

u16 LCD_read(void)
{
    u16 data;
    LCD_CS_CLR;
    LCD_RD_CLR;
    delay_us(1); //延时1us
    data = DATAIN;
    LCD_RD_SET;
    LCD_CS_SET;
    return data;
}

```

The FSMC test program is implemented as shown below:

```

u16 LCD_read(void)
{
    vu16 data; //防止被优化
    data=LCD->LCD_RAM;
    return data;
}

/*****
 * @name      :void LCD_WR_REG(u16 data)
 * @date      :2018-08-09
 * @function   :Write an 16-bit command to the LCD screen
 * @parameters :data:Command value to be written
 * @retvalue   :None
 *****/
void LCD_WR_REG(u16 data)
{
    LCD->LCD_REG=data; //写入要写的寄存器序号
}

/*****
 * @name      :void LCD_WR_DATA(u16 data)
 * @date      :2018-08-09
 * @function   :Write an 16-bit data to the LCD screen
 * @parameters :data:data value to be written
 * @retvalue   :None
 *****/
void LCD_WR_DATA(u16 data)
{
    LCD->LCD_RAM=data; //写入要写的的数据
}

```

Both 8- and 16-bit command writes and 8- and 16-bit data writes and reads are implemented.

- B. C51 test program parallel port communication code implementation
  - The relevant code is implemented in the LCD.c file as shown below:

```

void LCD_write(u8 HVAL,u8 LVAL)
{
    LCD_CS = 0;
    LCD_WR = 0;
    LCD_DataPortH = HVAL;
    LCD_DataPortL = LVAL;
    LCD_WR = 1;
    LCD_CS = 1;
}

u16 LCD_read(void)
{
    u16 d;
    LCD_CS = 0;
    LCD_RD = 0;
    delay_us(1); //delay 1 us
    d = LCD_DataPortH;
    d = (d<<8) | LCD_DataPortL;
    LCD_RD = 1;
    LCD_CS = 1;
    return d;
}

```

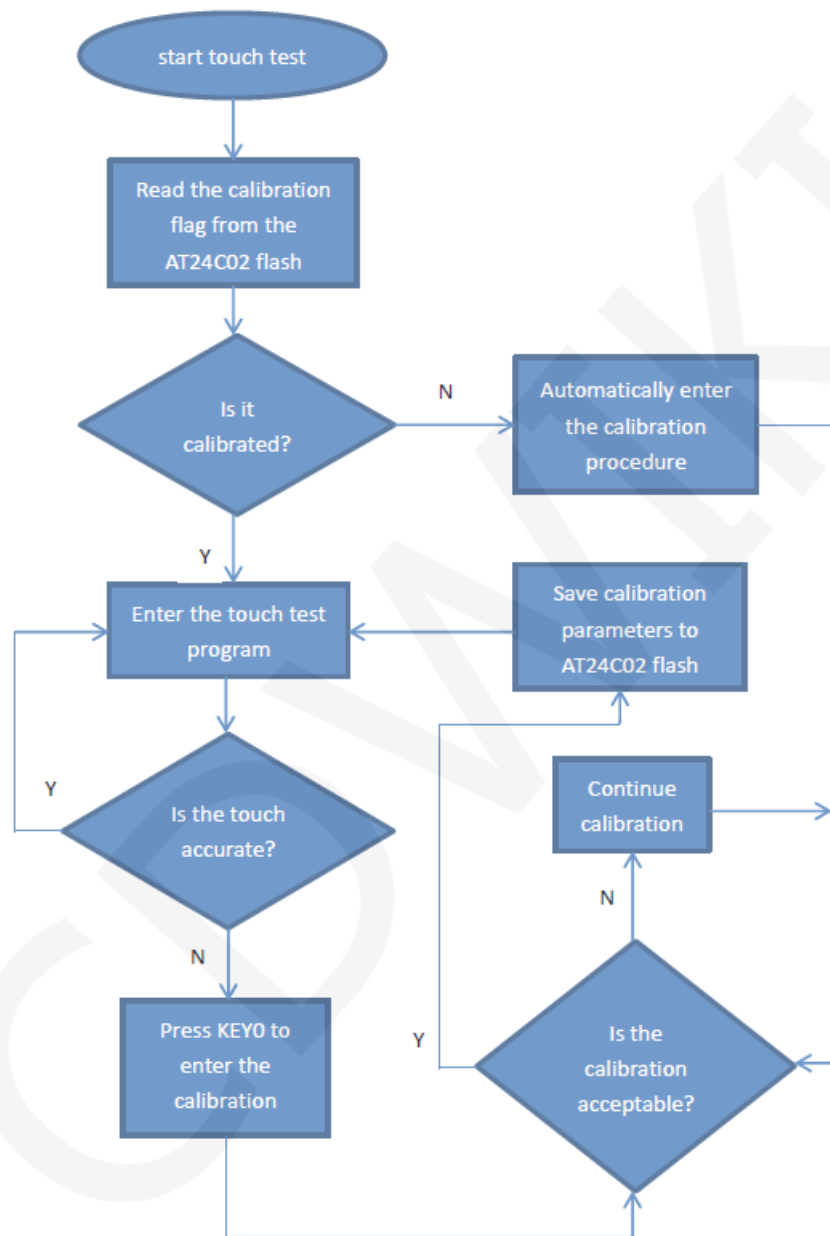
Implemented 8-bit and 16-bit commands and 8-bit and 16-bit data write and read.

#### 4. touch screen calibration instructions

- A. STM32 test program touch screen calibration instructions

The STM32 touch screen calibration program automatically recognizes whether calibration is required or manually enters calibration by pressing a button.

It is included in the touch screen test item. The calibration mark and calibration parameters are saved in the AT24C02 flash. If necessary, read from the flash. The calibration process is as shown below:



- B. C51 test program touch screen calibration instructions

The C51 touch screen calibration needs to execute the Touch\_Adjust test item (only available in the STC12C5A60S2 test program), as shown below:

```

//循环进行各项测试
while(1)
{
    main_test();    //测试主界面
    Test_Color();   //简单刷屏填充测试
    Test_FillRec(); //GUI矩形绘图测试
    Test_Circle();  //GUI画圆测试
    Test_Triangle(); //GUI三角形填充测试
    English_Font_test();//英文字体示例测试
    Chinese_Font_test();//中文字体示例测试
    Pic_test();     //图片显示示例测试
    Rotate_Test();
    //不使用触摸或者模块本身不带触摸，请屏蔽下面触摸屏测试
    Touch_Test();   //触摸屏手写测试
    //需要触摸校准时，请将触摸手写测试屏蔽，将下面触摸校准测试项打开
    // Touch_Adjust(); //触摸校准
}
  
```

After the touch calibration is passed, you need to save the calibration parameters displayed on the screen in the touch.c file, as shown below:

```

//***因触摸屏批次不同等原因，默认的校准参数值可能会引起触摸
u16 vx=11738,vy=7736; //比例因子，此值除以1000之后表示多少
u16 chx=3905,chy=246; //默认像素点坐标为0时的AD起始值
//***因触摸屏批次不同等原因，默认的校准参数值可能会引起触摸

```

## Common software

This set of test examples requires the display of Chinese and English, symbols and pictures, so the modulo software is used.

**There are two types of modulo software:**

Image2Lcd and PCtoLCD2002. Here is only the setting of the modulo software for the test program.

**The PCtoLCD2002 modulo software settings are as follows:**

- Dot matrix format select Dark code the modulo mode select the progressive mode
- Take the model to choose the direction (high position first)
- Output number system selects hexadecimal number
- Custom format selection C51 format

**The specific setting method is as follows:**

[http://www.lcdwiki.com/Chinese\\_and\\_English\\_display\\_modulo\\_settings](http://www.lcdwiki.com/Chinese_and_English_display_modulo_settings)

**Image2Lcd modulo software settings are shown below:**



The Image2Lcd software needs to be set to horizontal, left to right, top to bottom, and low position to the front scan mode.

## Documents / Resources



[LCD wiki MRB3514 3.5inch 16bit Parallel Port RTP and CTP Module](#) [pdf] User Manual  
MRB3514 3.5inch 16bit Parallel Port RTP and CTP Module, MRB3514, 3.5inch 16bit Parallel P  
ort RTP and CTP Module, Parallel Port RTP and CTP Module, RTP and CTP Module

## References

- [User Manual](#)